

Note:

1.Material:

- 1.1 Insulator: High temperature thermoplastic with g.f,UL94v-0
- 1.2 Contact: Copper alloy,t=0.25mm
- 1.3 Shell: Spcc,t=0.30mm

2.Specification:

- 2.1 Current rating: 1 A Max.
- 2.2 Dielectric withstanding voltage: 750 V(ac) for 1 min.
- 2.3 Contact resistance: 30 m WMax.
- 2.4 Insulation resistance: 1000 M WMin.
- 2.5 Total mating force: 4.0 Kgf Max.
- 2.6 Total unmating force: 1.0 Kgf Min.
- 2.7 Temperature range: -55°C~85°C

USB-SRxxxx-4A-LF

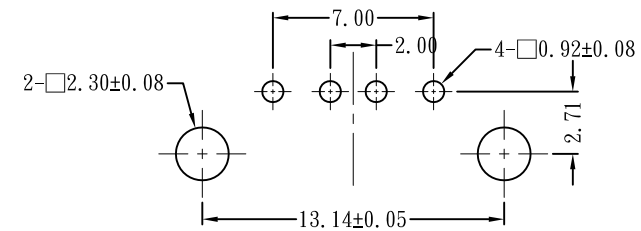
WH:WHITE
BK:BLACK

LEADFREE

S03:SEMI-GOLD 3u"
S30:SEMI-GOLD 30u"

S30:min.1.27um Ni all over;min.0.76um Au in the contact area of 4mm;min.0.1um Au on the rest of mating area (2mm);

RoHS Compliant



Recommended P. C. Board Hole Layout



PART NO. USB-SRxxxx-4A

DWG NO. USB-SRxxxx-4A

FILE NO.

APPROVED BY CY

DRAWING BY

TOLERANCES ARE
.X ± 0.25
.XX ± 0.15
.XXX ± 0.10
AWG

DESCRIPTION:
AREA

USB A TYPE 板端 90° (CUSTOMER DRAWING)			
REVISIONS	HK	DATE	

煜倫股份有限公司

UNIT / mm

SCALE 1:1

PROJECTION